<ul> <li>Qualified for Automotive Applications</li> <li>Member of Texas Instruments Widebus™</li> </ul>	DGG OR DL PACKAGE (TOP VIEW)			
Family	NC [		48 10E	
Standard '16245-Type Pinout	1B1 🛚		47 🛮 1A1	
<ul> <li>5-Ω Switch Connection Between Two Ports</li> </ul>	1B2 🛚		46 🛮 1A2	
TTL-Compatible Input Levels	GND 🛚		45 GND	
Latch-Up Performance Exceeds 100 mA Per	1B3 🛚		44 🛮 1A3	
JESD 78, Class II	1B4 🛚		43 🛮 1A4	
ESD Protection Exceeds JESD 22	V <sub>CC</sub>		42 V <sub>CC</sub>	
- 2000-V Human-Body Model (A114-A)	1B5 🛚		41 🛮 1A5	
- 2000-V Machine Model (A115-A)	1B6 🛚		40 1A6	
- 1000-V Machine Model (A113-A) - 1000-V Charged-Device Model (C101)	GND [		39 GND	
- 1000-V Charged-Device Woder (C101)	1B7 🛚		38 🛮 1A7	
description/ordering information	1B8 🛚		37 1A8	
acsomption/ordering information	2B1 🛚		36 2A1	
The SN74CBT16245 device provides 16 bits of	2B2 🛚		35 2A2	
high-speed TTL-compatible bus switching in a	GND [		34 🛮 GND	
standard '16245 device pinout. The low on-state	2B3 🛚	16	33 🛮 2A3	
resistance of the switch allows connections to be	2B4 🛚		32 2A4	
made with minimal propagation delay.	v <sub>cc</sub> [	18	31 V <sub>CC</sub>	
The device is organized as two 8-bit low-impedance	2B5 🛚		30 2A5	
switches with separate output-enable (OE) inputs.	2B6 🛚	20	29 🛮 2A6	
When OF is low the switch is on, and data can flow	GND [	21	28 GND	

### **ORDERING INFORMATION†**

2B7 **1** 22

2B8 [] 23

NC  $\Pi$ 

27 1 2A7

26 2A8

NC - No internal connection

1 20E

TA	PACKAGE <sup>‡</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
4000 1- 0500	SSOP – DL	Tape and reel	SN74CBT16245IDLRQ1§	CBT16245I	
-40°C to 85°C	TSSOP - DGG	Tape and reel	CCBT16245IDGGRQ1	CBT16245I	

<sup>†</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

When  $\overline{OE}$  is low, the switch is on, and data can flow

from the A port to the B port, or vice versa. When

OE is high, the switch is open, and the

high-impedance state exists between the two



ports.

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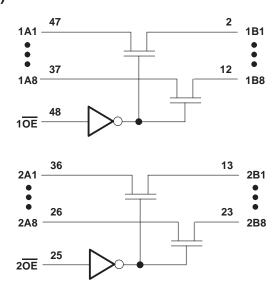
<sup>‡</sup> Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

<sup>§</sup> Product Preview

## FUNCTION TABLE (each 8-bit bus switch)

INPUT OE	FUNCTION
L	A port = B port
Н	Disconnect

### logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	
Input voltage range, V <sub>I</sub> (see Note 1)	. $-0.5 \text{ V}$ to 7 V
Continuous channel current	128 mA
Input clamp current, $I_{IK}$ ( $V_{I/O}$ < 0)	–50 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DGG package	70°C/W
DL package	63°C/W
Storage temperature range, T <sub>stq</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
  - 2. The package thermal impedance is calculated in accordance with JESD 51-7.

### recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
VCC	Supply voltage	4	5.5	V
VIH	High-level control input voltage	2		V
V <sub>IL</sub>	Low-level control input voltage		0.8	V
TA	Operating free-air temperature	-40	85	°C

NOTE 3: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PAR	AMETER		MIN	TYP†	MAX	UNIT		
VIK		$V_{CC} = 4.5 \text{ V},$	I <sub>I</sub> = -18 mA				-1.2	V
		$V_{CC} = 0$ ,	V <sub>I</sub> = 5.5 V				10	•
l <sub>l</sub>		$V_{CC} = 5.5 \text{ V},$	$V_I = 5.5 \text{ V or GND}$				±1	μΑ
Icc		$V_{CC} = 5.5 \text{ V},$	$I_{O} = 0$ ,	$V_I = V_{CC}$ or GND			3	μΑ
∆l <sub>CC</sub> ‡	Control inputs	$V_{CC} = 5.5 \text{ V},$	One input at 3.4 V,	Other inputs at V <sub>CC</sub> or GND			2.5	mA
Ci	Control inputs	V <sub>I</sub> = 3 V or 0				3.5		pF
C <sub>io(OFF)</sub>		$V_0 = 3 \text{ V or } 0,$	OE = V <sub>CC</sub>			4.5		pF
		$V_{CC} = 4 \text{ V},$ TYP at $V_{CC} = 4 \text{ V}$	V <sub>I</sub> = 2.4 V,	I <sub>I</sub> = 15 mA		14	20	
ron§	$v_{\text{OO}}$ $v_{\text{CC}} = 4.5 \text{ V}$ $v_{\text{I}} = 0$ $v_{\text{I}} = 64 \text{ mA}$ $v_{\text{I}} = 30 \text{ mA}$		I <sub>I</sub> = 64 mA			5	7	Ω
			I <sub>I</sub> = 30 mA		5	7		
			V <sub>I</sub> = 2.4 V,	I <sub>I</sub> = 15 mA		8	12	

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$  (unless otherwise noted),  $T_A = 25^{\circ}\text{C}$ .

## switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

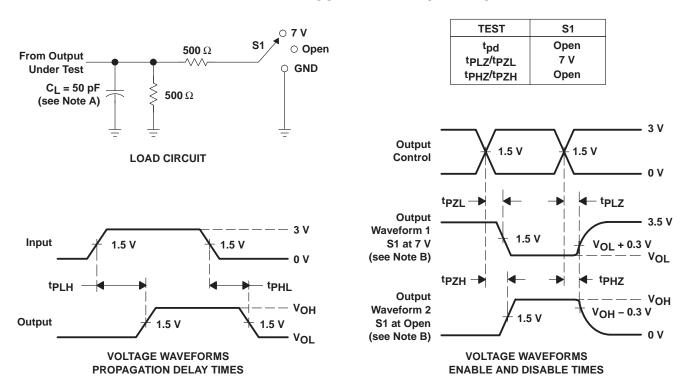
PARAMETER	FROM	TO	V <sub>CC</sub> = 4 V	UNIT		
	(INPUT)	(OUTPUT)	MIN MAX	MIN	MAX	
$t_{pd}\P$	A or B	B or A	0.35		0.25	ns
t <sub>en</sub>	ŌĒ	A or B	6.1	1.2	5.6	ns
<sup>t</sup> dis	ŌE	A or B	7.5	3.9	7.7	ns

The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

<sup>&</sup>lt;sup>‡</sup> This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V<sub>CC</sub> or GND.

<sup>§</sup> Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \,\Omega$ ,  $t_r \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F.  $\,$   $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}.$
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms





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#### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins P	ackage Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
CCBT16245IDGGRQ1	ACTIVE	TSSOP	DGG	48	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

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(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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#### OTHER QUALIFIED VERSIONS OF SN74CBT16245-Q1:

• Catalog: SN74CBT16245

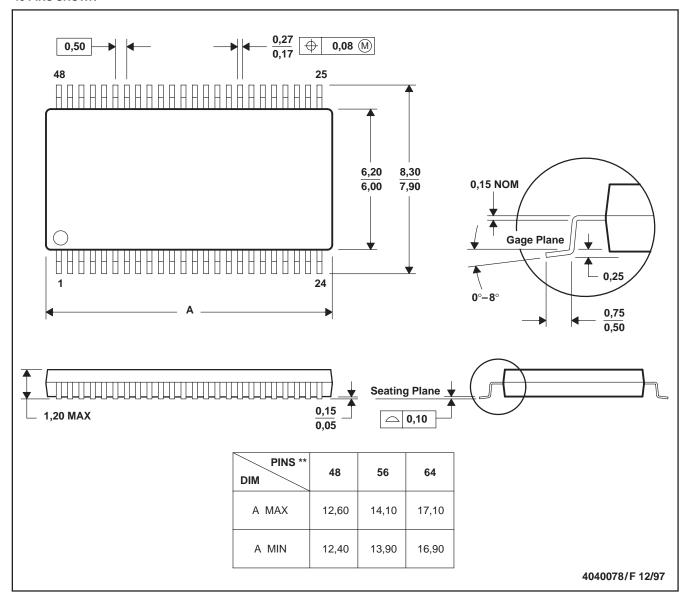
NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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